

SCLS591A - SEPTEMBER 2004 - REVISED APRIL 2008

## DESCRIPTION

The SN74LV8153 is a serial-to-parallel data converter. It accepts serial input data and outputs 8-bit parallel data.

The automatic data-rate detection feature of the SN74LV8153 eliminates the need for an external oscillator and helps with cost and board real-estate savings.

The OUTSEL pin is used to choose between open collector and push-pull outputs. The open-collector option is suitable when this device is used in applications such as LED interface, where high drive current is required. SOUT is the output that acknowledges reception of the serial data.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC1</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

PW PACKAGE (TOP VIEW)									
V <sub>CC1</sub> [ A0 [ A1 ] D [ OUTSEL ] RESET [ OE ] SOUT [ GND ]	1 2 3 4 5 6 7 8 9 10	20 19 18 17 16 15 14 13 12 11	V <sub>CC2</sub> Y0 Y1 Y2 Y3 Y4 Y5 Y6 Y7 GND						

### FEATURES

- Qualified for Automotive Applications
- Single-Wire Serial Data Input
- Compatible With UART Serial-Data Format
- Up to Eight Devices (64-Bit Parallel) Can Share the Same Bus by Using Different Combinations of A0, A1, A2
- Up to 40 mA Current Drive in Open-Collector Mode for Driving LEDs
- Outputs Can be Configured as Open-Collector or Push-Pull
- Internal Oscillator and Counter for Automatic Data-Rate Detection
- Output Levels Are Referenced to V<sub>CC2</sub> and Can Be Configured From 3 V to 12 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

### SUMMARY OF RECOMMENDED OPERATING CONDITIONS

PARAMETER	
V <sub>CC1</sub>	3 V to 5.5 V
V <sub>CC2</sub>	3 V to 13.2 V
IOL	40 mA @ V <sub>CC2</sub> = 4.5 V (open-collector mode)
ЮН	–24 mA @ V <sub>CC2</sub> = 12 V (push-pull mode)
Maximum Data Rate	24 Kbps



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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	(each buffer)										
	INPUT	OUTPUT	OUTPUT								
OUTSEL	RESET	OE	Dn	Yn	STRUCTURE						
L	Н	L	Н	L							
L	Н	L	L	Н							
L	Х	Н	Х	Н	Open collector						
L	L	Х	Х	Н							
Н	Н	L	Н	Н							
н	Н	L	L	L	Buch pull						
н	Х	Н	Х	Z	Push-pull						
н	L	L	Х	L							

## 

In the open-collector mode (OUTSEL = L), the outputs are inverted, e.g., Y1 = I, when D1 = H

### **ORDERING INFORMATION<sup>†</sup>**

TA	PACKAGE <sup>‡</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	TSSOP – PW	Tape and reel	SN74LV8153QPWRQ1	LV8153Q

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

<sup>‡</sup>Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

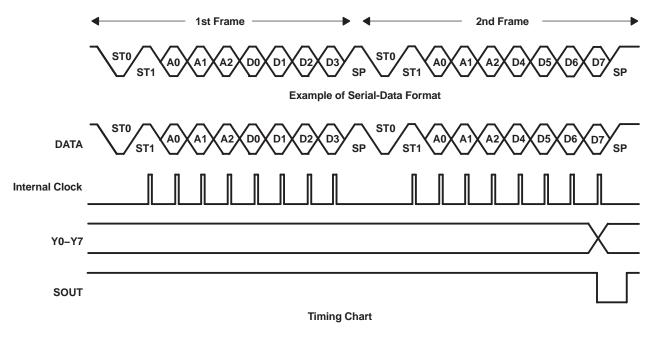
### PIN DESCRIPTION

PIN #	PIN NAME	I/O	PIN FUNCTION
1	VCC1		Power-supply pin (all inputs and outputs except for Y0-Y7)
2-4	A0, A1, A2	In	The address pins are used to program the address of the device and allow up to eight devices to share the same bus.
5	D	In	Serial data input
6	OUTSEL	In	Choose between open-collector and push-pull type outputs (Y0-Y7).
7	RESET	In	Initialize register status
8	OE	In	Force Y0-Y7 to Hi-Z
9	SOUT	Out	Outputs a pulse when latch data is changed. Supplied by $V_{CC1}$ .
12-19	Y0-Y7	Out	Push-pull or open collector parallel data outputs. Supplied by $V_{CC2}$ .
20	V <sub>CC2</sub>		Power-supply pin for outputs (Y0-Y7). V <sub>CC2</sub> can range from 3 V to 13.2 V.



### data transmission protocol

- The serial data should be sent as 2START-3ADDRESS-4DATA-1STOP. Two consecutive serial-data frames transmit 8 bits of data. The first frame includes the lower four bits of data (D0-D3), and the second frame includes the upper four bits (D4-D7).
- The three address bits (in the consecutive frame) must be the same as those in the first frame; otherwise, the data will be dropped.
- The order of the two start bits must be 0, then 1 in any frame; otherwise, the data rate will not be detected correctly. The period between the falling edge of the first start bit (ST0) and the rising edge of the second start bit (ST1) is measured to generate an internal-clock synchronized data stream.



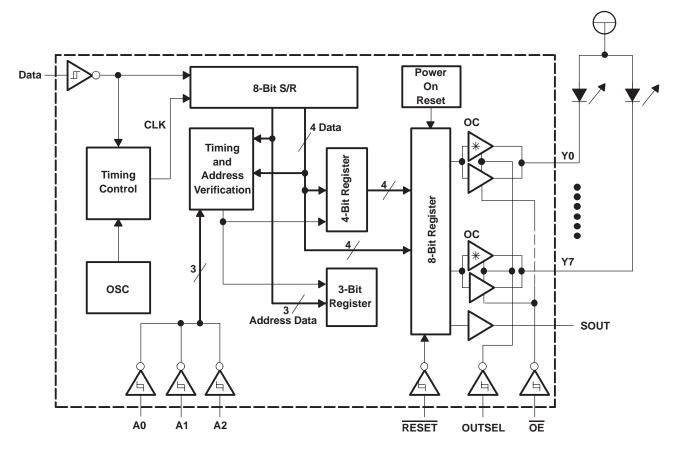
(1)Internal clock cannot be observed.

(1)D0 is LSB and D7 is MSB. The data stream should be LSB first.

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### logic diagram



### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

Supply voltage range, V <sub>CC1</sub>	
Input voltage range, $V_1^{(2)}$	
Voltage range applied to any output in the high or low state, $V_O$ (SOUT) <sup>(2)(3)</sup>	–0.5 V to V <sub>CC1</sub> + 0.5 V
Voltage range applied to any output in the high-impedance	
or power-off state, V <sub>O</sub> (SOUT) <sup>(2)</sup>	
Voltage range, applied to any output in the high or low state, V <sub>O</sub> (Y0-Y7) <sup>(2)(3)</sup>	-0.5 V to V <sub>CC2</sub> + 0.5 V
Voltage range applied to any output in the high-impedance	
or power-off state, V <sub>O</sub> (Y0-Y7) <sup>(2)</sup>	–0.5 V to 14.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	25 mA
Continuous current, I <sub>O</sub> (OUTSEL = L, Y0-Y7 = L)	60 mA
Package thermal impedance, $\theta_{JA}^{(4)}$	83°C/W
Storage temperature range, T <sub>stg</sub>	

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

 $^{(3)}$ The value of V<sub>CC</sub> is provided in the recommended operating condition table.

<sup>(4)</sup>The package thermal impedance is calculated in accordance with JESD 51-7.



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# recommended operating conditions<sup>(1)</sup>

				VCC1	V <sub>CC2</sub>	MIN	MAX	UNIT	
VCC1	Supply voltage					3	5.5	V	
V <sub>CC2</sub>	Supply voltage					3	13.2	V	
				3 V	3 V	V <sub>CC</sub> × 0.7			
VIH	High-level input voltage			4.5 V	4.5 V	$V_{CC} \times 0.7$		V	
Ma				3 V	3 V		$V_{CC}  imes 0.3$	V	
VIL	Low-level input voltage			4.5 V	4.5 V		$V_{CC}  imes 0.3$	V	
VI	Input voltage					0	5.5	V	
	Output will an		4.5 V	4.5 V	0	5.5	V		
VO	Output voltage				12 V	0	13.2	v	
			OUTSEL = H	3 V	3 V		-2		
		Yn		4.5 V	4.5 V		-8	mA	
IOH	High-level output current			4.5 V	12 V		-24		
				3 V	3 V		-4		
		SOUT		4.5 V	4.5 V		-8	mA	
				3 V	3 V		2		
		N.	OUTSEL = H	4.5 V	4.5 V		8		
		Yn		3 V	3 V		20		
IOL	Low-level output current		OUTSEL = L	4.5 V	4.5 V		40	mA	
		00117			3 V		4		
		SOUT		4.5 V	4.5 V		8		
TA	Operating free-air temperature	•	·	1		-40	125	°C	

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETI	ER	TEST CONDITIO	NS	V <sub>CC1</sub>	V <sub>CC2</sub>	MIN	TYP MAX	UNIT		
V <sub>T+</sub>				3.3 V	3.3 V		2.31			
Positive-going input voltage	t threshold	All inputs	5 V	5 V		3.5	V			
V <sub>T</sub> -				3.3 V	3.3 V	0.99				
Negative-going input voltage	it threshold	All inputs	5 V	5 V	1.5		V			
ΔVT				3.3 V	3.3 V	0.33	1.32			
Hysteresis (V <sub>T+</sub> – V <sub>T-</sub>		All inputs	5 V	5 V	0.5	2	V			
		I <sub>OH</sub> = -2 mA	3 V	3 V	2.38					
	Yn	I <sub>OH</sub> = -8 mA		4.5 V	4.5 V	3.8				
VOH		I <sub>OH</sub> = -24 mA	4.5 V	12 V	11		V			
	0.0117	$I_{OH} = -4 \text{ mA}$	3 V	3 V	2.38					
	SOUT	I <sub>OH</sub> = -8 mA		4.5 V	4.5 V	3.8				
		I <sub>OL</sub> = 2 mA (OUTSEL = H)	3 V	3 V		0.44				
	Yn	I <sub>OL</sub> = 8 mA (OUTSEL = H)	4.5 V	4.5 V		0.44				
VOL		I <sub>OL</sub> = 40 mA (OUTSEL = L)	4.5 V	4.5 V		0.5	V			
		I <sub>OL</sub> = 4 mA		3 V	3 V		0.44			
	SOUT	I <sub>OL</sub> = 8 mA		4.5 V	4.5 V		0.44			
lj		$V_{I} = 5.5 V \text{ or GND}$		0 to 5.5 V			±1	μA		
I <sub>OZ</sub>		$V_{O} = V_{CC}$ or GND (OUTSEL	= H)	5.5 V	5.5 V		±5	μA		
IOH		$V_{O} = 12 V (OUTSEL = L)$		5.5 V	5.5 V		5	μA		
ICC		$V_{I} = V_{CC} \text{ or GND}, I_{O} = 0$ OUTSEL = H OUTSEL = L		5.5 V	5.5 V		5	mΑ		
I <sub>off</sub> (except	SOUT)	$V_{I} \text{ or } V_{O} = 0 \text{ to } 5.5 \text{ V}, V_{CC} = 0$	0	0		±50	μA			
Ci		$V_{I} = V_{CC} \text{ or } GND$	5 V	5 V		5	pF			

# switching characteristics over recommended operating free-air temperature range, $V_{CC1} = V_{CC2} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figures 1 and 2)

	FROM	то	LOAD	Т	<b>₄ = 25°C</b>	;			UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
	D7	Y			Pw/2	(1)			
tpd RESET Y	Pw/2	(1)							
	RESET	Y						220	ns
	<u>OE</u> (2)	Y	CL = 50 pF					220	
<sup>t</sup> en	<u>OE</u> (3)	Y						220	ns
<sup>t</sup> dis	<u>OE</u> (3)	Y						220	ns
t <sub>W</sub>		SOUT			Pw	(4)			ns
Data rate							2	24	Kbps

(1) The t<sub>pd</sub> is dependent on the data pulse width (Pw), and Y outputs are changed after one-half of Pw, because the internal clock is synchronized at the middle of the data pulse. Not tested, but specified by design.
 (2) When outputs are open collector (OUTSEL = L)

(3) When outputs are push-pull (OUTSEL = H)

(4) SOUT goes low when the data is received correctly and maintains a low level for one data-pulse period. Not tested, but specified by design.

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switching	characteristics	over	recommended	operating	free-air	temperature	range,
$V_{CC1} = V_{CC}$	$_{ m C2}$ = 5 V $\pm$ 0.5 V (u	nless	otherwise noted)	(see Figures	and 2)		-

DADAMETED	FROM	то	LOAD	Тд	∖ = 25°C	;			
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
	D7	Y			Pw/2	(1)			
tpd D7 SOUT		Pw/2	(1)						
rbq	RESET	Y	-					200	ns
	<u>OE</u> (2)	Y	CL = 50 pF					200	
ten	<u>OE</u> (3)	Y						200	ns
<sup>t</sup> dis	<u>OE</u> (3)	Y						200	ns
t <sub>W</sub>		SOUT	]		Pw	(4)			ns
Data rate							2	24	Kbps

(1) The t<sub>pd</sub> is dependent on the data pulse width (Pw), and Y outputs are changed after one-half of Pw, because the internal clock is synchronized at the middle of the data pulse. Not tested, but specified by design.
 (2) When outputs are open collector (OUTSEL = L)

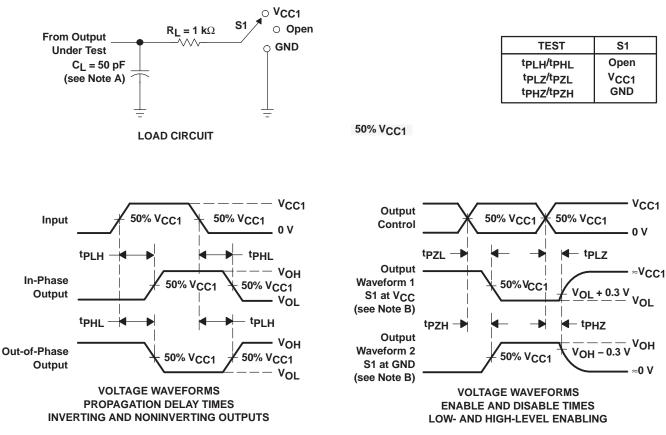
(3) When outputs are push-pull (OUTSEL = H)

(4) SOUT goes low when the data is received correctly and maintains a low level for one data-pulse period. Not tested, but specified by design.



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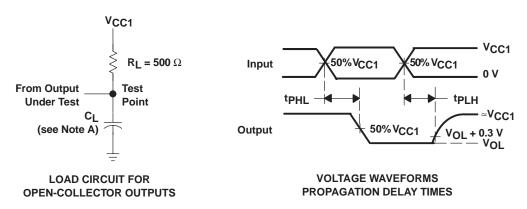
- NOTES: A. CI includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $Z_{O} = 50 \Omega$ ,  $t_{f} \le 3 ns$ ,  $t_{f} \le 3 ns$ .
  - D. The outputs are measured one at a time, with one input transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F. tp71 and tp7H are the same as  $t_{en}$ .
  - G. tpHL and tpLH are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

### Figure 1. Load Circuit and Voltage Waveforms



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### PARAMETER MEASUREMENT INFORMATION (OPEN-COLLECTOR OUTPUT)



- NOTES: A. CL includes probe and jig capacitance.
  - B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  3 ns, t<sub>f</sub>  $\leq$  3 ns.
  - C. The outputs are measured one at a time, with one input transition per measurement.
  - D.  $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms



10-Dec-2020

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LV8153QPWRG4Q1	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV8153Q	Samples
SN74LV8153QPWRQ1	ACTIVE	TSSOP	PW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LV8153Q	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### OTHER QUALIFIED VERSIONS OF SN74LV8153-Q1 :

Catalog: SN74LV8153

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV8153QPWRG4Q1	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
SN74LV8153QPWRQ1	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

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# PACKAGE MATERIALS INFORMATION

17-Dec-2020



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV8153QPWRG4Q1	TSSOP	PW	20	2000	853.0	449.0	35.0
SN74LV8153QPWRQ1	TSSOP	PW	20	2000	853.0	449.0	35.0

PW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES:

A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.  $\beta$ . This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



## LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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